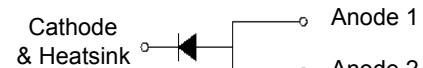


## Features

- Low profile - typical height 1.1 mm
- Low forward voltage drop
- Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- High temperature soldering guaranteed: 260°C/10 seconds
- Halogen-free according to IEC 61249-2-21 definition



Package:  
 eSGC (TO-277)



## Applications

For low voltage high frequency inverters, DC/DC converters and polarity protection applications.

Schematic Diagram

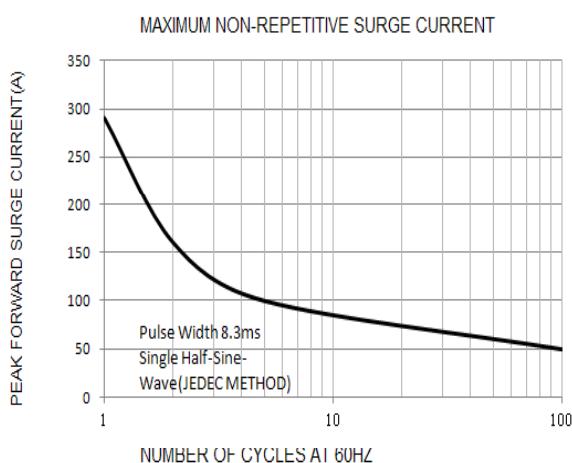
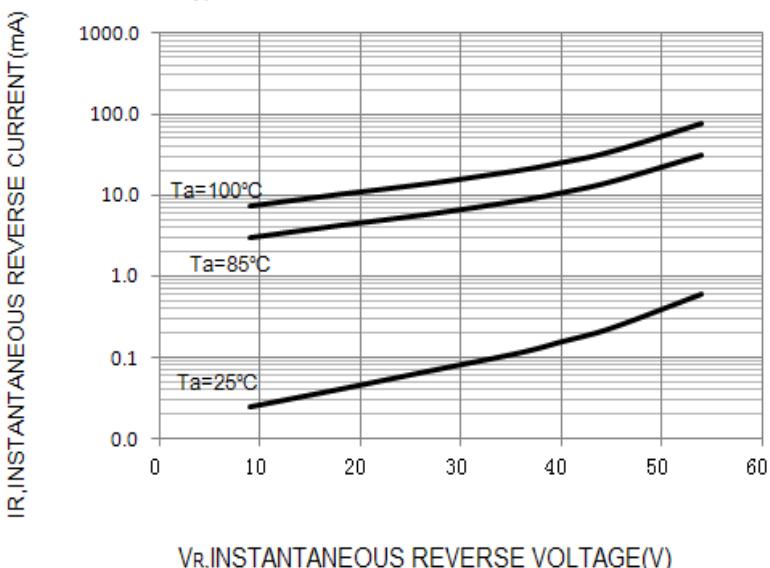
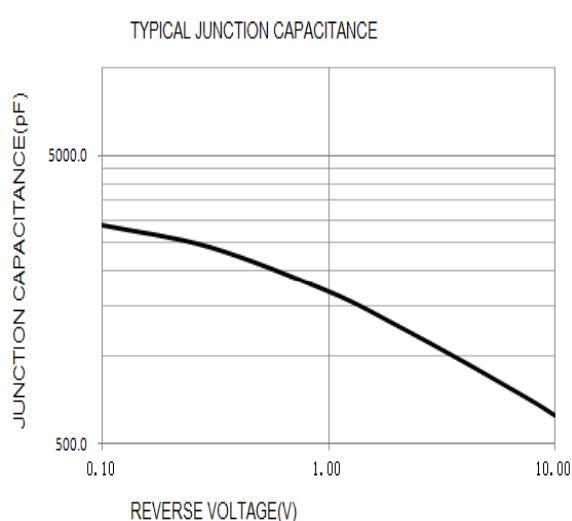
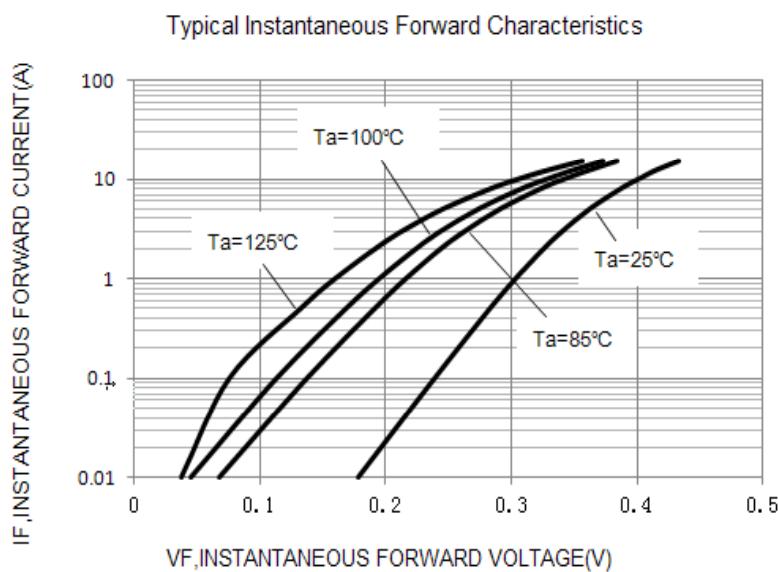
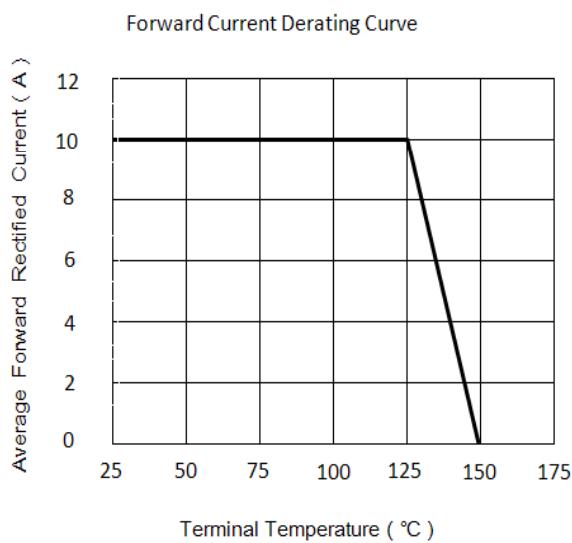
## Maximum Ratings ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	60	V
Maximum RMS Voltage	V <sub>RMS</sub>	42	V
Maximum DC Blocking Voltage	V <sub>D</sub>	60	V
Maximum Average Forward Rectified Current	I <sub>F(AV)</sub>	10	A
Peak Forward Surge Current (8.3ms single half sine-wave superimposed on rated load)	I <sub>FSM</sub>	280	A
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

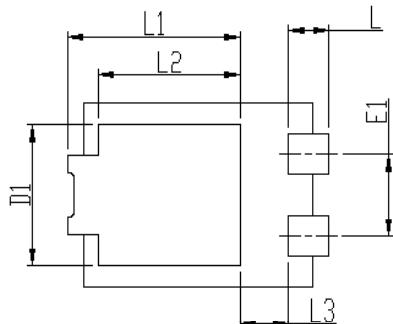
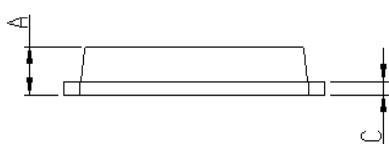
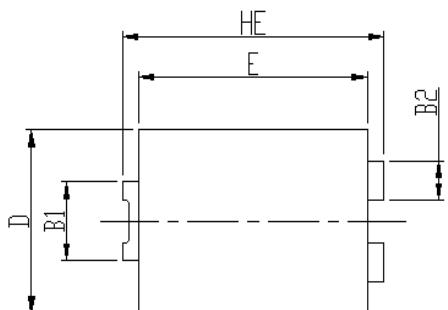
## Electrical Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Test Conditions		Symbol	Typ.	Max.	Unit	
Maximum Instantaneous Forward Voltage	I <sub>F</sub> =1A	T <sub>A</sub> =25°C	V <sub>F</sub>	0.30	0.35	V	
	I <sub>F</sub> =2A			0.33	0.38		
	I <sub>F</sub> =10A			0.45	0.5		
	I <sub>F</sub> =1A	T <sub>A</sub> =85°C		0.22	0.27		
	I <sub>F</sub> =2A			0.25	0.3		
	I <sub>F</sub> =10A			0.44	0.48		
	I <sub>F</sub> =1A	T <sub>A</sub> =125°C		0.16	0.20		
	I <sub>F</sub> =2A			0.20	0.24		
	I <sub>F</sub> =10A			0.43	0.46		
Maximum DC Reverse Current at Rated DC Blocking Voltage	Rated V <sub>R</sub>	T <sub>A</sub> =25°C	I <sub>R</sub>	0.18	0.3	mA	
		T <sub>A</sub> =85°C		14	18		
		T <sub>A</sub> =100°C		35	39		
Junction Capacitance	4.0 V, 1 MHz		C <sub>J</sub>	950		pF	
Typical Thermal Resistance	Junction to Lead		R <sub>θJL</sub>	60		°C/W	

**Ratings and Characteristics Curves** ( $T_A = 25^\circ C$  unless otherwise noted)



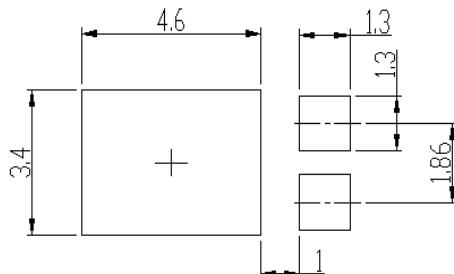
## Package Outline Dimensions



## eSGC (TO-277)

DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
HE	6.4	6.6	0.252	0.260
E	5.6	5.8	0.220	0.228
D	4.1	4.3	0.161	0.169
B1	1.7	1.9	0.067	0.075
B2	0.8	1	0.031	0.039
A	1.05	1.2	0.041	0.047
C	0.3	0.4	0.012	0.016
L	0.85	1.1	0.033	0.043
L1	4.2	4.4	0.165	0.173
L2	3.52	Typ.	0.139	Typ.
L3	1.1	1.4	0.043	0.055
D1	3	3.3	0.118	0.130
E1	1.86	Typ.	0.073	Typ.

## Soldering footprint



## Packing Information

### Packing quantities

5000 pcs/Reel, 12 mm Tape, 13" Reel

### Tape & Reel Specification

